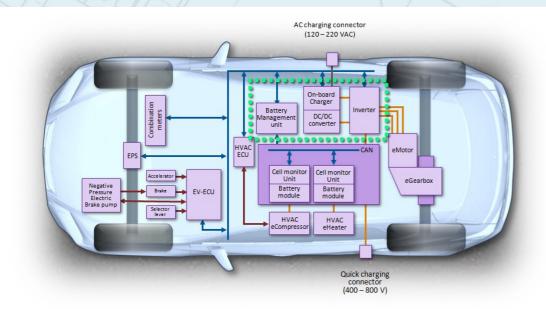




COMPONENTS



Advanced Solutions for Driving and Protecting Power Switches



By Maurizio Di Paolo Emilio, editor-in-chief of Power Electronics News

Today, new power switch technologies are being widely adopted in demanding applications in which high power density, high switching frequency, and small form factor are critical requirements. The three key applications in which these new switch devices make a difference are:

- 1. Automotive (traction inverters, DC/DC converters, and on-board chargers)
- 2. Industrial/motor control (point-of-load supplies, uninterruptible power supplies, robotics, motor control)
- 3. Power supply/solar (solar inverters, telecom power supplies, servers/cloud/PC power supplies)

Power switches are fabricated either using conventional silicon-based technology, such as MOSFETs and insulated-gate bipolar transistors (IGBTs), or using the more recent wide-bandgap semiconductors, such as silicon carbide and gallium nitride. Among the relevant applications, automotive is the sector that has gained more momentum in recent years, mainly due to the undergoing transition toward e-mobility and the progressive adoption of electric vehicles.

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As shown in Figure 1, EVs integrate a multitude of sensors and electronic circuits, including a high-voltage bus (400 V, 800 V, or more) and a local low-voltage bus. SiC devices are replacing the Si-based counterparts in high-voltage systems, such as on-board chargers, battery management systems, main DC/DC converters, and traction inverters.

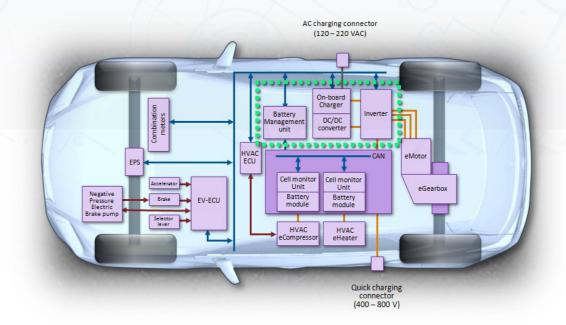


Figure 1: Switch technology in EV systems

The high-voltage bus poses serious safety concerns, and it must be galvanically isolated from the low-voltage bus while still allowing the exchange of information, in both directions, between the two voltage domains.

SKYWORKS ISOLATED GATE DRIVERS

Skyworks Solutions, a leading company that provides highly innovative analog semiconductors for wireless networking applications, has recently completed the acquisition of the infrastructure and automotive business of Silicon Labs. Addressing the growth in key automotive segments, including electric and hybrid vehicles, Skyworks provides high-performance and robust isolated gate drivers for silicon, GaN, and SiC power switches.

Charlie Ice, product manager at Skyworks Solutions, held a technical presentation on "Driving and Protecting the Power Switches of the Future" at PowerUP Expo 2021, talking about key gate driver requirements and protection methods for both Si-based and wide-bandgap power devices. The same topics will be presented in this article.

"Especially in EVs, we have to make sure that the high-voltage and the low-voltage sides remain isolated while at the same time ensuring they can still communicate and exchange information through that barrier," said Charlie.

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The features of the isolation device are even more important for new switching technologies, like SiC and GaN, which can achieve higher efficiencies but are more sensitive and easier to damage. Therefore, those new switching technologies require unique protections to operate both safely and reliably.

Traditionally, power-electronic systems have relied on IGBTs, the least expensive solution per watt at high power and high voltage. However, IGBTs have slower switching speed, thus limiting the efficiency of the system. That's where SiC and GaN have both stepped in to really drive higher efficiency. One disadvantage for both is that they can't take as many fault conditions as an IGBT can, and that's why they need additional protection.

In high-voltage systems, for safety reasons, we must separate the high-voltage side from the low-voltage side. Often, designers decide to keep the controller on the low-voltage side so it is away from the noise and from big transients. The controller generates the pulse-width-modulation (PWM) signals and passes them across the isolation barrier to a gate driver, which basically amplifies the low-voltage PWM signal to a higher signal able to turn the power device on and off.

The two main functions performed by an isolated gate driver are to level-shift 3-V or 5-V signals to higher-voltage rails of 24 V or 30 V and to supply switching current for charging/discharging the gate capacitor. By adding a galvanic isolation barrier, this device achieves two main benefits:

- 1. It provides input-to-output isolation for protection of the controller, and perhaps personnel, from high voltages and voltage transients.
- 2. It helps to maintain noise-immune operation for best efficiency. High-voltage transients can disrupt operation, resulting in loss of modulation and thus efficiency.

The isolated gate driver can be safely used to switch even high-power switches, such as silicon or superjunction MOSFETs, IGBTs, and wide-bandgap switches like GaN and SiC. Isolated gate drivers are available in many flavors: single-channel, dual-channel, and ones that can generate a high-side and a low-side signal from a single PWM input.

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"I typically find that many automotive systems use single-channel drivers because they make the board-layer layout easier; however, dual-channel drivers and high-side/low-side drivers are very popular in power supply systems," said Charlie.

Regarding protection, one of the key methods is the Miller clamp. Its function is to monitor the voltage on the gate, and if it gets too high, it clamps it. Basically, it's an active monitor to ensure the gate is always off. However, Miller clamp protection is not enough for SiC and GaN power devices, which are more sensitive and get damaged more quickly. The other feature we need to add for driving

SiC or GaN devices, improving their protection and longevity, is desaturation detection and soft shutdown.

In a high-power system, such as a traction inverter, it's not uncommon that power devices experience a momentary overcurrent condition. In this case, an isolated gate driver with desat detection can monitor the voltage (V_{CE}) across the power switch. If it detects

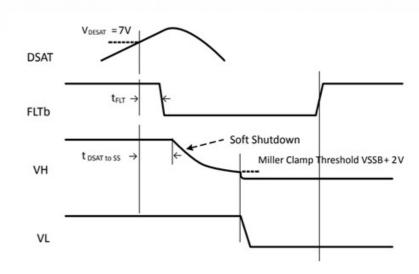


Figure 2: Desaturation protection with fault indication

too much voltage across it (see Figure 2), which would indicate a fault condition, it automatically shuts it off in a very safe way, also known as soft shutdown. However, it is important to set the device off quickly enough to avoid being damaged. Here, we can see how switching devices behave differently. An IGBT, for instance, needs to be turned off within 3 μ s, while a SiC device needs to be shut down within 1.2 μ s and a GaN device within 200 ns.

"These are the two key techniques — Miller clamp and desaturation detection — that have become really critical for driving SiC and GaN successfully and making the system reliable and, in many ways, safe," said Charlie.

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- ► Electric vehicles
- ▶ BMS Solutions for a Long and Safe Battery Life

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Measurement System for GaN and SiC Semiconductor Analysis

New 1 GHz probes, 12-bit High Definition Oscilloscopes and test software combine to provide ultimate accuracy for SiC and GaN testing. Teledyne LeCroy has announced the launch of their new DL-ISO High Voltage Optically Isolated 1 GHz Probe and Power-Device test software, which when combined with their High Definition Oscilloscopes (HDO®) offer the most accurate electrical characterization of gallium nitride (GaN) and silicon carbide (SiC) power semiconductor devices.

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EV Test Systems Business Acquisition

By providing EV fully integrated test systems, NI will help enable customers to achieve the scale at which the EV market is growing. NI has announced that it has entered into a definitive agreement to purchase the test systems business of Kratzer Automation AG, a European leader in providing holistic customer solutions for electrification (EV). This agreement further expands NI's investment in the high growth area of vehicle electrification and enhances customer connections with key original equipment manufacturers (OEM).

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SiC MOSFETs for High Performance Applications

SemiQ's SiC MOSFETs bring high efficiency to high-performance applications including electric vehicles, power supplies and data centers. SemiQ, Inc. is proud to announce the release of its second-generation Silicon Carbide 1200V 80mΩ Power MOSFET modules developed in the industry-standard SOT-227 packages. These 1200V Silicon Carbide MOSFET Modules are the latest extension to our SiC MOSFET product portfolio.

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SuperGaN FETs Power Computing PSU

Transphorm's SuperGaN FETs help Boco Electronics deliver more bits with less watts at a lower overall system cost. Transphorm, Inc., along with Boco Electronics, has announced that the electronics company's 3.6 kW power supply uses SuperGaN® FETs. The robust 12volt AC-to-DC power supply achieves a peak efficiency of greater than 96% and is designed to be used in rugged environments caused by ultra-demanding applications such as blockchain and high-performance datacenter systems.

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APEC 2022—Back in-person, finally! - Podcast

APEC 2022—Back in-person, finally! – Podcast

Many people from academia and industry had the chance to discuss the most recent developments in GaN and SiC during the latest edition of APEC, which was held March 21-24, 2022 in Houston.

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SiC's Cost Competitiveness

In several energy industries, the silicon carbide (SiC) industry is expanding to provide highly efficient and Silicon carbide (SiC) is expanding in several energy industries to deliver extremely efficient and compact solutions.

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GaN Technology - Podcast

GaN improves the efficiency of power-conversion stages, making it a viable alternative to silicon in the manufacture of high-efficiency voltage converters. GaN has a number of advantages over silicon, including higher energy efficiency, smaller size, reduced weight, and cheaper total cost.

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Getting Commercial Fusion Running by 2030 - Podcast

As **electrification** spreads to new applications, global power consumption is predicted to double by 2040 and maybe fivefold by 2060.

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Power saving methods for LTE-M and NB-IoT

LTE-M and NB-IoT require long battery lifetime to ensure IoT services and minimize maintenance costs in the future. This technical white paper describes the possible power saving methods that can be applied to LTE-M and NB-IoT devices.

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Improved energy efficiency and growing demand for longer battery life are prompting the power electronics community to take yet another hard look at the tradeoffs presented by wide-bandgap semiconductor technology operating at higher voltages, temperatures, and frequencies.

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